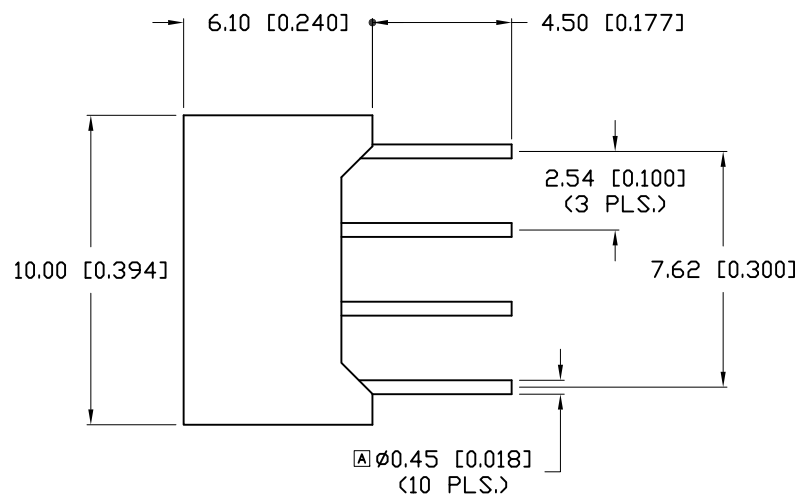
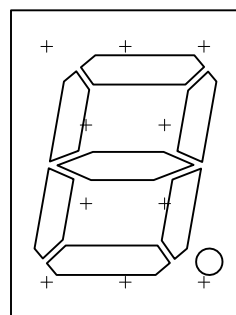
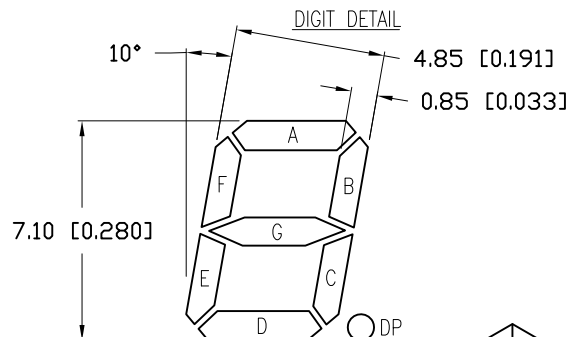
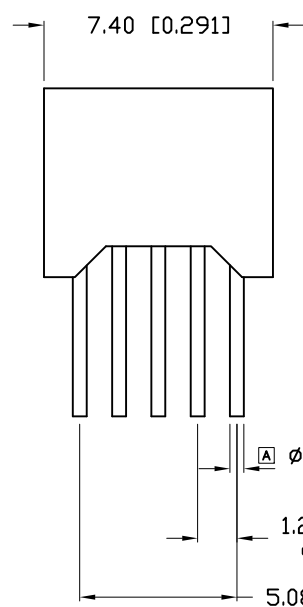


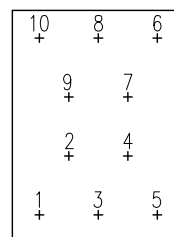
PART NUMBER	LDS-C2803RI-SY	REV.	B
DATE	E.C.N. NUMBER AND REVISION COMMENTS		
12.11.09	E.C.N. #11601.		
03.07.13	E.C.N. #10BRDR. & REDRAWN.		
		REV.	A
			B

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=10\text{mA}$

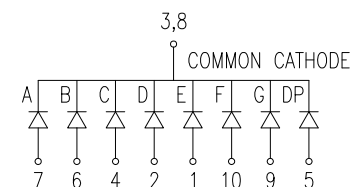
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		590		nm	
FORWARD VOLTAGE		2.0	2.5	V_f	
REVERSE VOLTAGE	5.0			V_r	$I_r=100\mu\text{A}$
AXIAL INTENSITY		15000		μcd	$I_f=10\text{mA}$
EMITTED COLOR:	YELLOW				
FACE COLOR:	GRAY				
SEGMENT COLOR:	MILKY WHITE DIFFUSED				



PIN LAYOUT TOP VIEW

LIMITS OF SAFE OPERATION AT 25°C PER CHIP

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	mW/ $^\circ\text{C}$
OPERATING, STORAGE TEMP.	-30 TO +85	$^\circ\text{C}$
SOLDERING TEMP.	+260	$^\circ\text{C}$
2.0mm FROM BODY	3 SEC. MAX	

* $t < 10\mu\text{s}$ 

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= $\frac{+0.00}{-0.00}$ DECIMAL PRECISION MAX= $\frac{+0.00}{-0.00}$ DECIMAL PRECISION

UNCONTROLLED DOCUMENT